

PATENT NUMBER

U.S. UTILITY Patent Application

O.I.P.E

PATENT DATE

SCANNED

0

APPLICATION NO. 09/531,163	CONT/PRIOR F	CLASS 438	SUBCLASS 692	ART UNIT 1725	EXAMINER Pee
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INVENTOR
Aqueous dispersion, aqueous dispersion for chemical mechanical
polishing used for manufacture of semiconductor devices, method for
manufacture of semiconductor devices, and method for formation of
embedded wiring

PTO-2040
12/99

[illegible]

<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS		CLAIMS ALLOWED	
	Sheets Drwg. 7	Figs. Drwg. 13	Print Fig. 8	Total Claims 20
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.	DUY-VIL DEO 4/28/03 _____ (Assistant Examiner) (Date)		NOTICE OF ALLOWANCE MAILED	
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____	_____ (Primary Examiner) (Date)		ISSUE FEE	
			Amount Due	Date Paid
<input type="checkbox"/> The terminal _____ months of this patent have been disclaimed.	_____ (Legal Instruments Examiner) (Date)		ISSUE BATCH NUMBER	

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